

Data Sheet	January 2002	

150A, 600V Ultrafast Diode

The RURU15060 is an ultrafast diode with soft recovery characteristics (t_{rr} < 85ns). It has low forward voltage drop and is of silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and ultrafast recovery with soft recovery characteristic minimizes ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Formally developmental type TA09925.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RURU15060	TO-218	RURU15060

NOTE: When ordering, use the entire part number.

Symbol



Features

•	Ultrafast with Soft Recovery	<85ns
•	Operating Temperature	175°C
•	Reverse Voltage	.600V

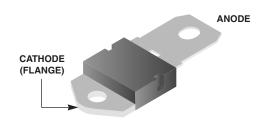
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- · Power Switching Circuits
- General Purpose

Packaging

JEDEC STYLE SINGLE LEAD TO-218



Absolute Maximum Ratings $T_C = 25^{\circ}C$, Unless Otherwise Specified

	RURU15060	UNITS
Peak Repetitive Reverse Voltage	600	V
Working Peak Reverse VoltageV _{RWM}	600	V
DC Blocking Voltage	600	V
Average Rectified Forward Current $I_{F(AV)}$ ($T_C = 85^{\circ}C$)	150	Α
Repetitive Peak Surge Current	300	Α
Nonrepetitive Peak Surge Current	1500	Α
Maximum Power Dissipation	375	W
Avalanche Energy (See Figure 7 and 8)	50	mJ
Operating and Storage Temperature	-65 to 175	°C

 $\textbf{Electrical Specifications} \hspace{0.5cm} \textbf{T}_{C} = 25^{o}\text{C, Unless Otherwise Specified}$

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
V _F	I _F = 150A	-	-	1.6	V
	I _F = 150A, T _C = 150°C	-	-	1.4	V
I _R	V _R = 600V	-	-	250	μΑ
	V _R = 600V, T _C = 150 ^o C	-	-	3.0	mA
t _{rr}	$I_F = 1A$, $dI_F/dt = 100A/\mu s$	-	-	85	ns
	$I_F = 150A$, $dI_F/dt = 100A/\mu s$	-	-	100	ns
t _a	$I_F = 150A$, $dI_F/dt = 100A/\mu s$	-	60	-	ns
t _b	I _F = 150A, dI _F /dt = 100A/μs	-	30	-	ns
$R_{ heta JC}$		-	-	0.4	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 t_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.

 t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle.

Typical Performance Curves

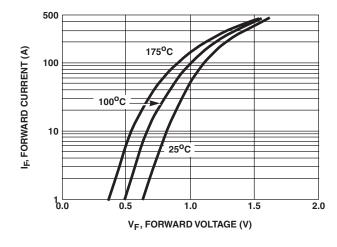


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

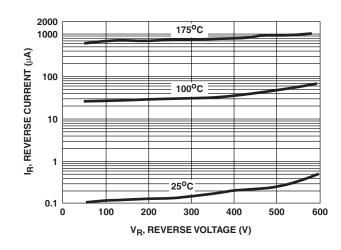


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

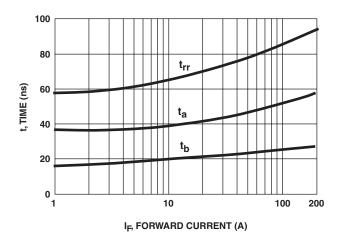


FIGURE 3. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

160 DC DC SQ. WAVE SQ. WAVE TC, CASE TEMPERATURE (°C)

FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

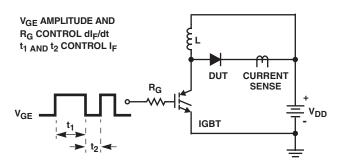


FIGURE 5. t_{rr} TEST CIRCUIT

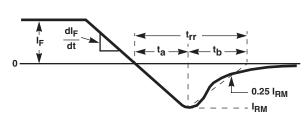


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

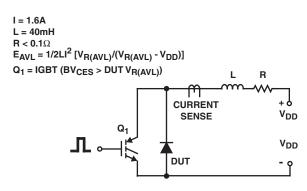


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

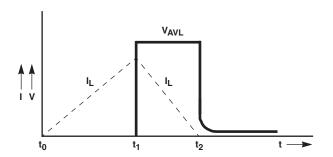


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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